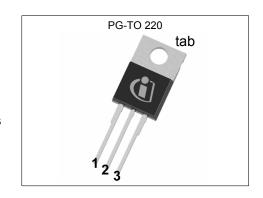


### **MOSFET**

#### 650V CoolMOS™ CFD7 SJ Power Device

The latest 650 V CoolMOS™ CFD7 extends the voltage class offering of the CFD7 family and is a successor to the 650 V CoolMOS™ CFD2. Resulting from improved switching performance and excellent thermal behavior, 650 V CooMOS™ CFD7 offers highest efficiency in resonant switching topologies, such as LLC and phase-shift-full-bridge (ZVS). As part of Infineon's fast body diode portfolio, this new product series blends all advantages of a fast switching technology together with superior hard commutation robustness. The CoolMOS™ CFD7 technology meets highest efficiency and reliability standards and furthermore supports high power density solutions.



#### **Features**

- · Ultra-fast body diode
- 650V break down voltage
- Best-in-class R<sub>DS(on)</sub>
- · Reduced switching losses
- Low R<sub>DS(on)</sub> dependency over temperature

#### **Benefits**

- Excellent hard commutation ruggedness
- · Extra safety margin for designs with increased bus voltage
- Enabling increased power density solutions
- Outstanding light load efficiency in industrial SMPS applications
- Improved full load efficiency in industrial SMPS applications
- Price competitiveness over previous CoolMOS™ families

### Potential applications

Suitable for Soft Switching topologies Optimized for phase-shift full-bridge (ZVS), LLC Applications – Server, Telecom, EV Charging, Solar



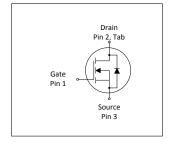
Fully qualified according to JEDEC for Industrial Applications

Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.



Parameter	Value	Unit
V <sub>DS</sub> @ T <sub>j,max</sub>	700	V
R <sub>DS(on),max</sub>	60	mΩ
$Q_{g,typ}$	68	nC
$I_{D,pulse}$	146	A
E <sub>oss</sub> @ 400V	9.5	μJ
Body diode di <sub>F</sub> /dt	1300	A/µs

Type / Ordering Code	Package	Marking	Related Links
IPP65R060CFD7	PG-TO220-3	65R060F7	see Appendix A













### **Table of Contents**

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# 1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 **Maximum ratings** 

Demonstra	0		Values			Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	-	-	36 23	А	T <sub>C</sub> =25°C T <sub>C</sub> =100°C	
Pulsed drain current <sup>2)</sup>	I <sub>D,pulse</sub>	-	-	146	Α	T <sub>C</sub> =25°C	
Avalanche energy, single pulse	<b>E</b> AS	-	-	171	mJ	I <sub>D</sub> =5.1A; V <sub>DD</sub> =50V; see table 10	
Avalanche energy, repetitive	<b>E</b> AR	-	-	0.86	mJ	I <sub>D</sub> =5.1A; V <sub>DD</sub> =50V; see table 10	
Avalanche current, single pulse	I <sub>AS</sub>	-	-	5.1	Α	-	
MOSFET dv/dt ruggedness	dv/dt	-	-	120	V/ns	V <sub>DS</sub> =0400V	
Gate source voltage (static)	V <sub>GS</sub>	-20	-	20	V	static;	
Gate source voltage (dynamic)	V <sub>GS</sub>	-30	-	30	V	AC (f>1 Hz)	
Power dissipation	P <sub>tot</sub>	-	-	171	W	<i>T</i> <sub>C</sub> =25°C	
Storage temperature	$T_{ m stg}$	-55	-	150	°C	-	
Operating junction temperature	T <sub>j</sub>	-55	-	150	°C	-	
Mounting torque	-	-	-	60	Ncm	M3 and M3.5 screws	
Continuous diode forward current <sup>1)</sup>	Is	-	-	36	Α	<i>T</i> <sub>C</sub> =25°C	
Diode pulse current <sup>2)</sup>	I <sub>S,pulse</sub>	-	-	146	Α	<i>T</i> <sub>C</sub> =25°C	
Reverse diode dv/dt <sup>3)</sup>	dv/dt	-	-	70	V/ns	$V_{\rm DS}$ =0400V, $I_{\rm SD}$ <=16.4A, $T_{\rm j}$ =25°C see table 8	
Maximum diode commutation speed	di <sub>F</sub> /dt	-	-	1300	A/μs	$V_{DS}$ =0400V, $I_{SD}$ <=16.4A, $T_{j}$ =25°C see table 8	
Insulation withstand voltage	V <sub>ISO</sub>	-	-	n.a.	V	$V_{\rm rms}$ , $T_{\rm C}$ =25°C, $t$ =1min	

 $<sup>^{1)}</sup>$  Limited by  $T_{j\,\text{max}}.$   $^{2)}$  Pulse width  $t_p$  limited by  $T_{j,\text{max}}$   $^{3)}$  Identical low side and high side switch with identical  $R_G$ 

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### 2 Thermal characteristics

### **Table 3** Thermal characteristics

Davamatav	Symbol	Values			11	Nata / Tast Camdition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R <sub>thJC</sub>	-	-	0.73	°C/W	-	
Thermal resistance, junction - ambient		-	-	62	°C/W	leaded	
Thermal resistance, junction - ambient for SMD version	$R_{thJA}$	-	-	-	°C/W	n.a.	
Soldering temperature, wavesoldering only allowed at leads	$T_{sold}$	-	-	260	°C	1.6mm (0.063 in.) from case for 10s	

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### **Electrical characteristics**

at T<sub>j</sub>=25°C, unless otherwise specified

Table 4 **Static characteristics** 

Damamatan.	Ol	Values					
Parameter	Symbol	Symbol Min. Typ. Max.		Unit	Note / Test Condition		
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	650	-	-	V	$V_{GS}$ =0V, $I_D$ =1mA	
Gate threshold voltage $V_{(GS)th}$ 3.5 4		4	4.5	V	$V_{DS}=V_{GS}$ , $I_{D}=0.86$ mA		
Zero gate voltage drain current <sup>1)</sup>	I <sub>DSS</sub>	-	- 13	1 37	μΑ	V <sub>DS</sub> =650V, V <sub>GS</sub> =0V, T <sub>j</sub> =25°C V <sub>DS</sub> =650V, V <sub>GS</sub> =0V, T <sub>j</sub> =125°C	
Gate-source leakage current	I <sub>GSS</sub>	-	-	100	nA	V <sub>GS</sub> =20V, V <sub>DS</sub> =0V	
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	0.052 0.115	0.060	Ω	V <sub>GS</sub> =10V, I <sub>D</sub> =16.4A, T <sub>j</sub> =25°C V <sub>GS</sub> =10V, I <sub>D</sub> =16.4A, T <sub>j</sub> =150°C	
Gate resistance	<b>R</b> <sub>G</sub>	-	5.8	-	Ω	f=1MHz, open drain	

Table 5 **Dynamic characteristics** 

Demonstra	Or week all		Values				
Parameter	Symbol	Min.	Тур.	Тур. Мах.		Note / Test Condition	
Input capacitance	Ciss	-	3288	-	pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =400V, <i>f</i> =250kHz	
Output capacitance	Coss	-	51	-	pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =400V, f=250kHz	
Effective output capacitance, energy related <sup>2)</sup>	C <sub>o(er)</sub>	-	119	-	pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =0400V	
Effective output capacitance, time related <sup>3)</sup> - $I_D$ =constant		I <sub>D</sub> =constant, V <sub>GS</sub> =0V, V <sub>DS</sub> =0400V					
Turn-on delay time	t <sub>d(on)</sub>	-	31	-	- ns $V_{DD}$ =400V, $V_{GS}$ =13V, $I_{D}$ =16.4A $R_{G}$ =5.3 $\Omega$ ; see table 9		
Rise time	t <sub>r</sub>	-	14	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =16.4A, $R_{\rm G}$ =5.3 $\Omega$ ; see table 9	
Turn-off delay time	t <sub>d(off)</sub>	-	114	114 - ns $V_{DD}$ =400V, $V_{GS}$ =13V, $I_{D}$ =16.4A, $R_{G}$ =5.3Ω; see table 9			
		$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =16.4A, $R_{\rm G}$ =5.3 $\Omega$ ; see table 9					

Table 6 **Gate charge characteristics** 

Davagastav	Cyronia al		Values			Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Gate to source charge	$Q_{ m gs}$	-	19	-	nC	$V_{DD}$ =400V, $I_{D}$ =16.4A, $V_{GS}$ =0 to 10V	
Gate to drain charge	$Q_{ m gd}$	-	21	-	nC	$V_{DD}$ =400V, $I_{D}$ =16.4A, $V_{GS}$ =0 to 10V	
Gate charge total	Qg	-	68	-	nC	V <sub>DD</sub> =400V, I <sub>D</sub> =16.4A, V <sub>GS</sub> =0 to 10V	
Gate plateau voltage	$V_{ m plateau}$	-	5.7	-	V	$V_{DD}$ =400V, $I_{D}$ =16.4A, $V_{GS}$ =0 to 10V	

 $<sup>^{1)}</sup>$  Maximum specification is defined by calculated six sigma upper confidence bound  $^{2)}$   $C_{\rm o(er)}$  is a fixed capacitance that gives the same stored energy as  $C_{\rm oss}$  while  $V_{\rm DS}$  is rising from 0 to 400V  $^{3)}$   $C_{\rm o(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{\rm oss}$  while  $V_{\rm DS}$  is rising from 0 to 400V

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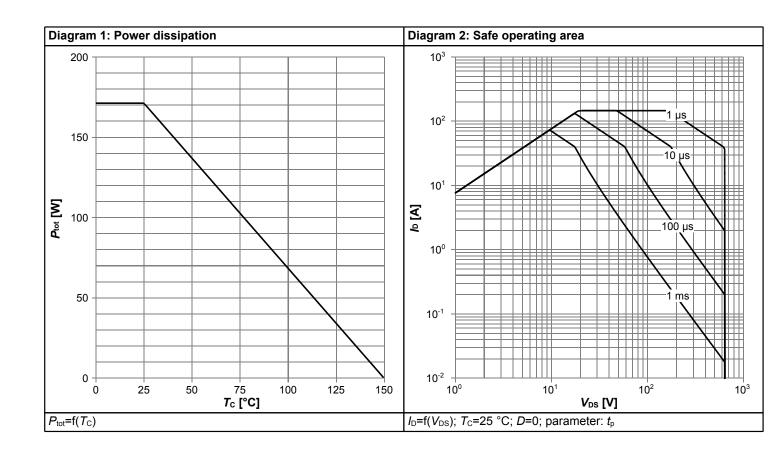


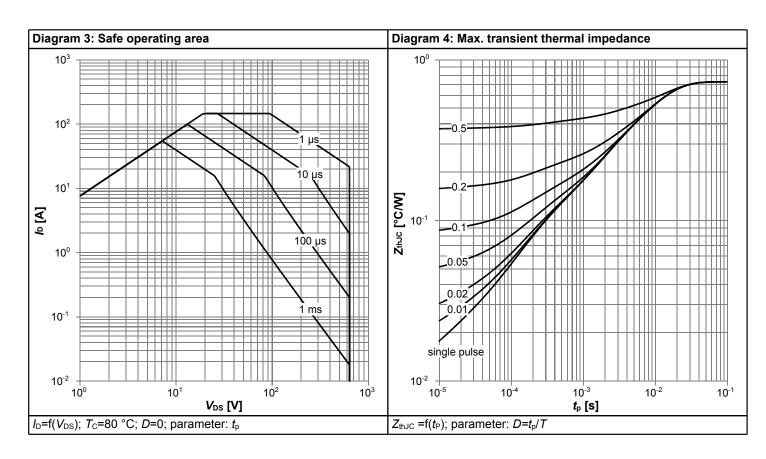
Table 7 Reverse diode characteristics

Doromotor	Symbol		Values		Linit	Note / Test Condition	
Parameter	Symbol	Min.			Unit	Note / Test Condition	
Diode forward voltage	<b>V</b> <sub>SD</sub>	-	1.0	-	V	V <sub>GS</sub> =0V, I <sub>F</sub> =16.4A, T <sub>j</sub> =25°C	
Reverse recovery time	t <sub>rr</sub>	-	156	234	ns	$V_R$ =400V, $I_F$ =16.4A, $di_F/dt$ =100A/ $\mu$ s; see table 8	
Reverse recovery charge	Qrr	-	0.86	1.72	μC	$V_R$ =400V, $I_F$ =16.4A, $di_F/dt$ =100A/ $\mu$ s; see table 8	
Peak reverse recovery current	I <sub>rrm</sub>	-	10.1	-	А	$V_R$ =400V, $I_F$ =16.4A, $di_F/dt$ =100A/ $\mu$ s; see table 8	

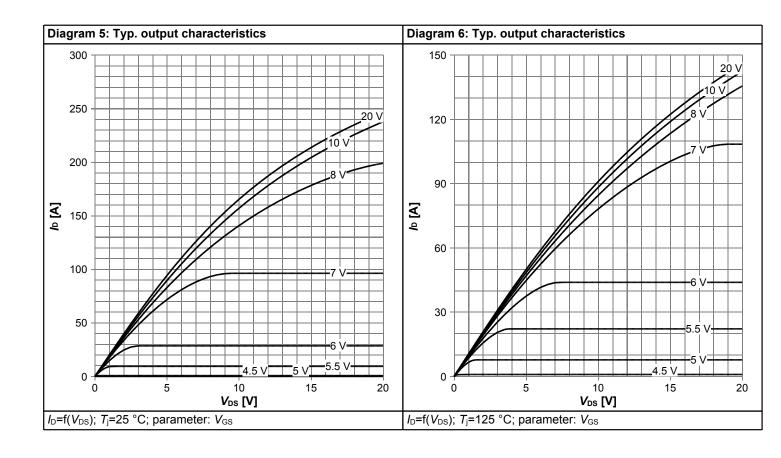


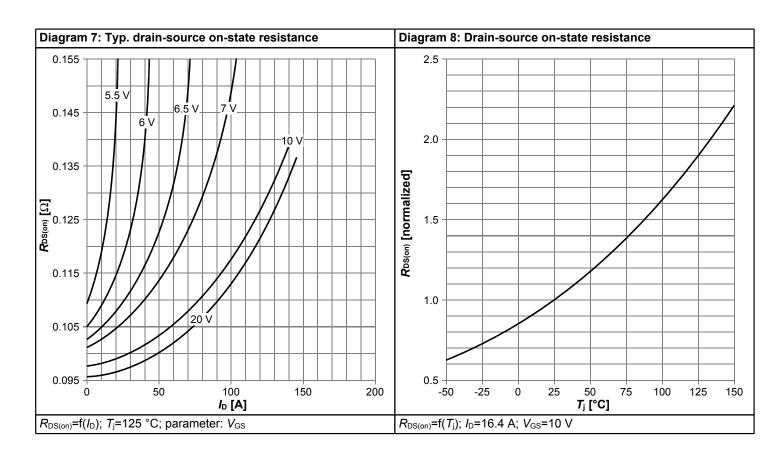
### 4 Electrical characteristics diagrams



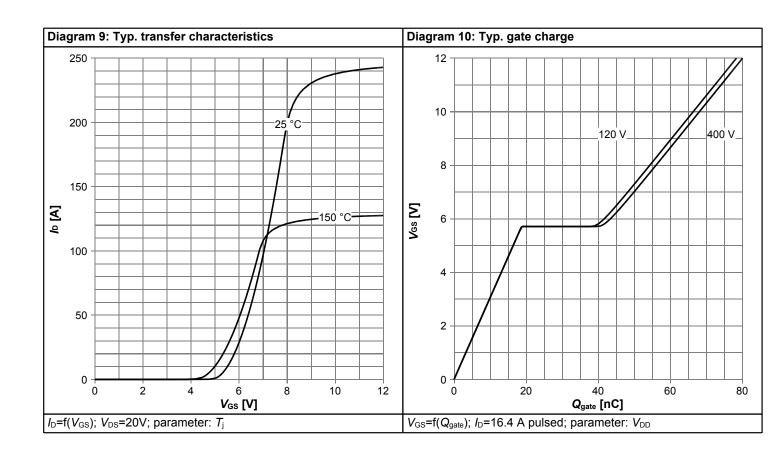


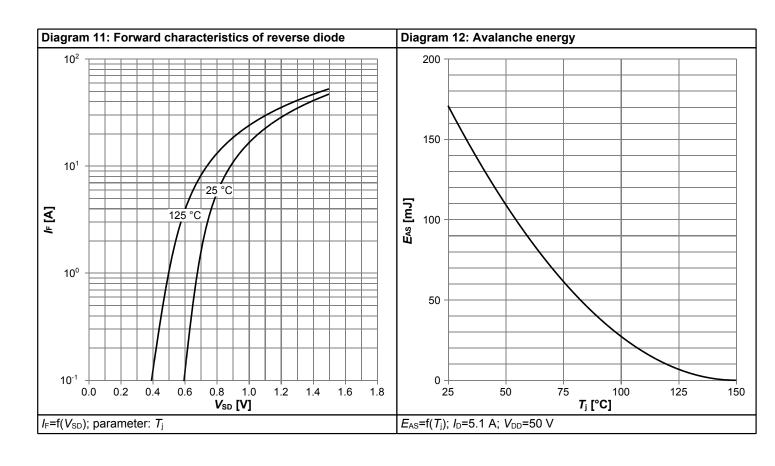




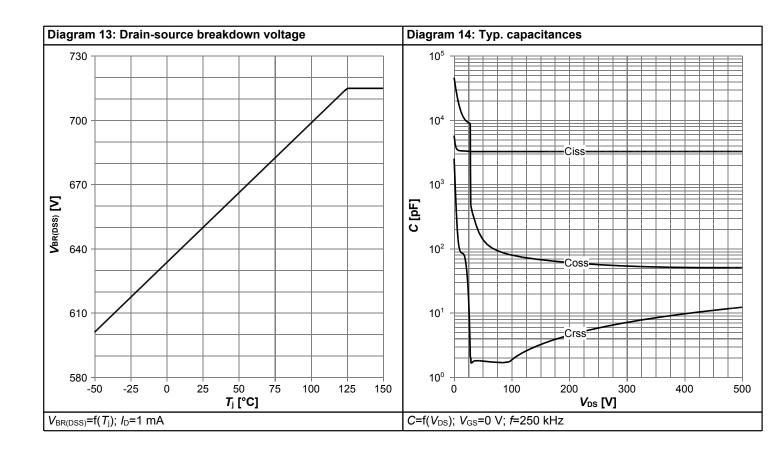


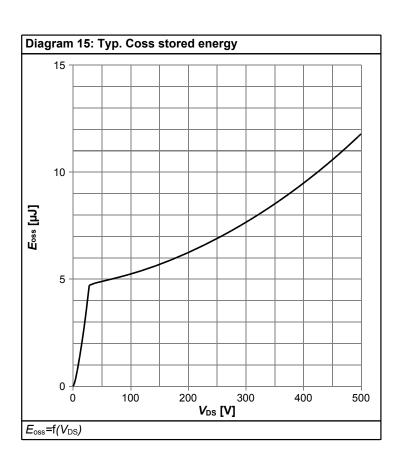














### 5 Test Circuits

**Table 8** Diode characteristics

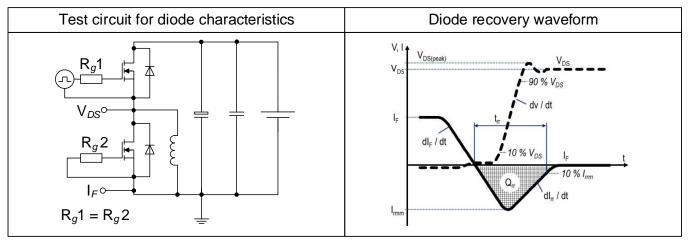
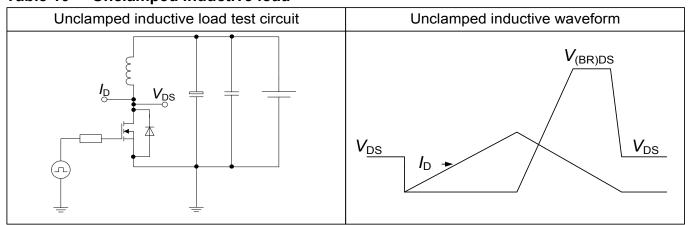


Table 9 Switching times

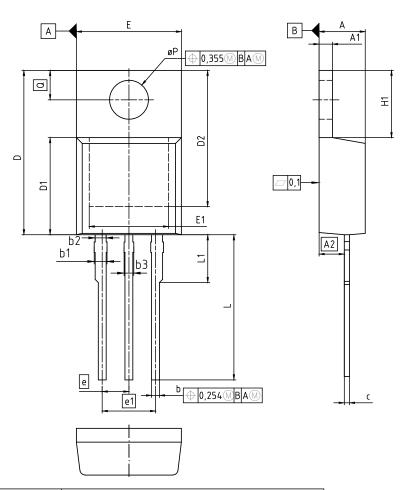


Table 10 Unclamped inductive load





# 6 Package Outlines



DIM	MILLIN	METERS	INCI	HES	
DIM	MIN	MAX	MIN	MAX	
Α	4.30	4.57	0.169	0.180	
A1	1.17	1.40	0.046	0.055	
A2	2.15	2.72	0.085	0.107	
b	0.65	0.86	0.026	0.034	
b1	0.95	1.40	0.037	0.055	
b2	0.95	1.15	0.037	0.045	
b3	0.65	1.15	0.026	0.045	
С	0.33	0.60	0.013	0.024	
D	14.81	15.95	0.583	0.628	
D1	8.51	9.45	0.335	0.372	
D2	12.19	13.10	0.480	0.516	
E	9.70	10.36	0.382	0.408	
E1	6.50	8.60	0.256	0.339	
е	2.	54	0.100		
e1	5.	08	0.2	200	
N		3	;	3	
H1	5.90	6.90	0.232	0.272	
L	13.00	14.00	0.512	0.551	
L1	-	4.80	-	0.189	
øΡ	3.60	3.89	0.142	0.153	
Q	2.60	3.00	0.102	0.118	

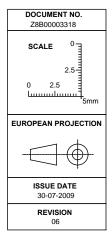


Figure 1 Outline PG-TO220-3, dimensions in mm/inches

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### 7 Appendix A

### Table 11 Related Links

• IFX CoolMOS CFD7 650V Webpage: www.infineon.com

• IFX CoolMOS CFD7 650V application note: www.infineon.com

• IFX CoolMOS CFD7 650V simulation model: www.infineon.com

• IFX Design tools: www.infineon.com

#### IPP65R060CFD7



#### **Revision History**

IPP65R060CFD7

Revision: 2020-08-12, Rev. 2.1

Previous Revision

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Revision	Date	Subjects (major changes since last revision)						
2.0	2020-06-23	Release of final version						
2.1	2020-08-12	Increased continuous diode forward current rating						

#### **Trademarks**

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Final Data Sheet 14 Rev. 2.1, 2020-08-12